## TRANSMITTAL OF FORMAL DRAWINGS

Docket No. FIS920040069US1

In Re Application Of: Bedell et al.

OCT 2 4 2005

Serial No.

Filing Date

atch No.

Examiner

Art Unit

10/710,826

08/05/2004

N/A

not yet assigned

2812

Invention: METHOD OF FORMING STRAINED SILICON MATERIALS WITH IMPROVED THERMAL

**CONDUCTIVITY** 

Address to:

**Assistant Commissioner for Patents** Washington, D.C. 20231

Transmitted herewith are:

2 sheets of formal drawing(s) for this application.

Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c) on the reverse side of the drawing.

Signature

Dated: October 19, 2005

Jay H. Anderson Registration No. 38,371 Telephone No. 845-894-3667 Fax No. 845-892-6363

I certify that this document and attached formal drawings are being deposited on October 12,2005 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

Signature of Person Mailing Correspondence

Robert Faber

Typed or Printed Name of Person Mailing Correspondence